



PBSS302PX

20 V, 5.1 A PNP low V_{CEsat} transistor

23 January 2024

Product data sheet

1. General description

PNP low V_{CEsat} transistor in a SOT89 (SC-62/TO-243) small and flat lead Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS302NX

2. Features and benefits

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors
- AEC-Q101 qualified

3. Applications

- DC-to-DC conversion
- MOSFET gate driving
- Motor control
- Charging circuits
- Power switches (e.g. motors, fans)

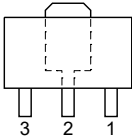
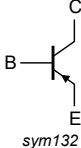
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-20	V
I _C	collector current		-	-	-5.1	A
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	-	-10.2	A
R _{CEsat}	collector-emitter saturation resistance	I _C = -4 A; I _B = -200 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	32	48	mΩ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	 SOT89	 sym132
2	C	collector		
3	B	base		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBSS302PX	SOT89	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	SOT89

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PBSS302PX	%5J

[1] % = placeholder for manufacturing site code

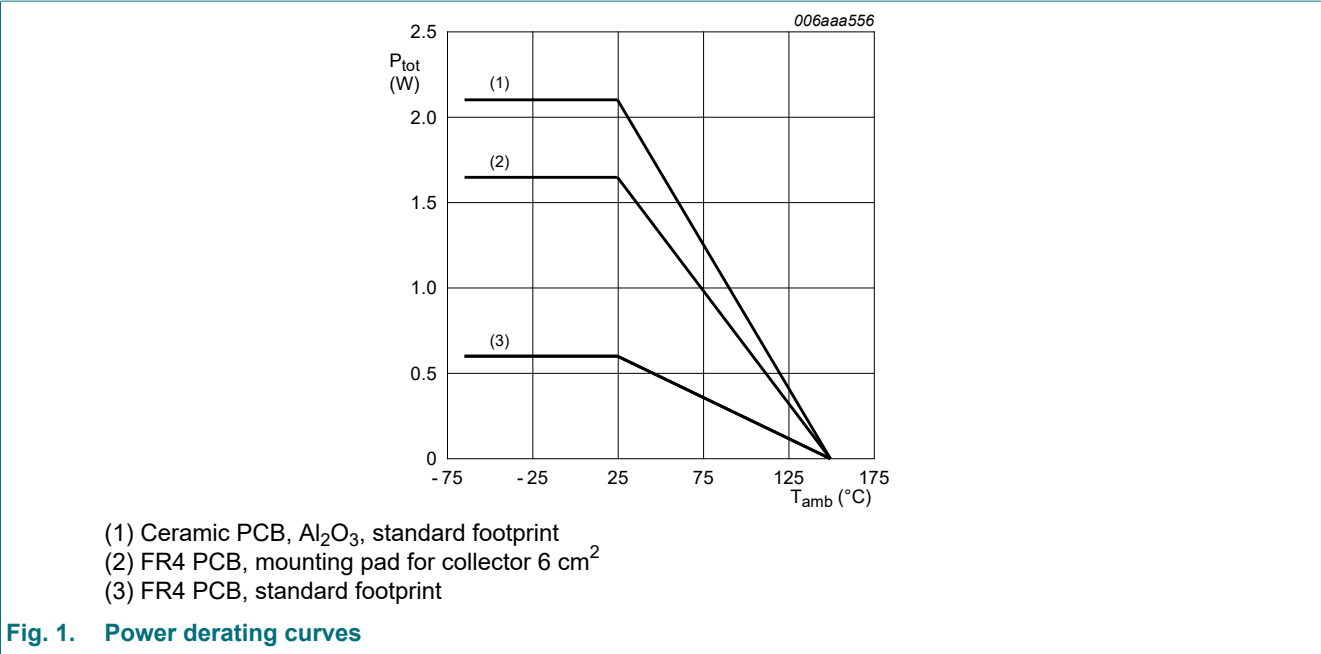
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	-20	V
V _{CEO}	collector-emitter voltage	open base		-	-20	V
V _{EBO}	emitter-base voltage	open collector		-	-5	V
I _C	collector current			-	-5.1	A
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-10.2	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.6	W
			[2]	-	1.65	W
			[3]	-	2.1	W
T _j	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².
[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

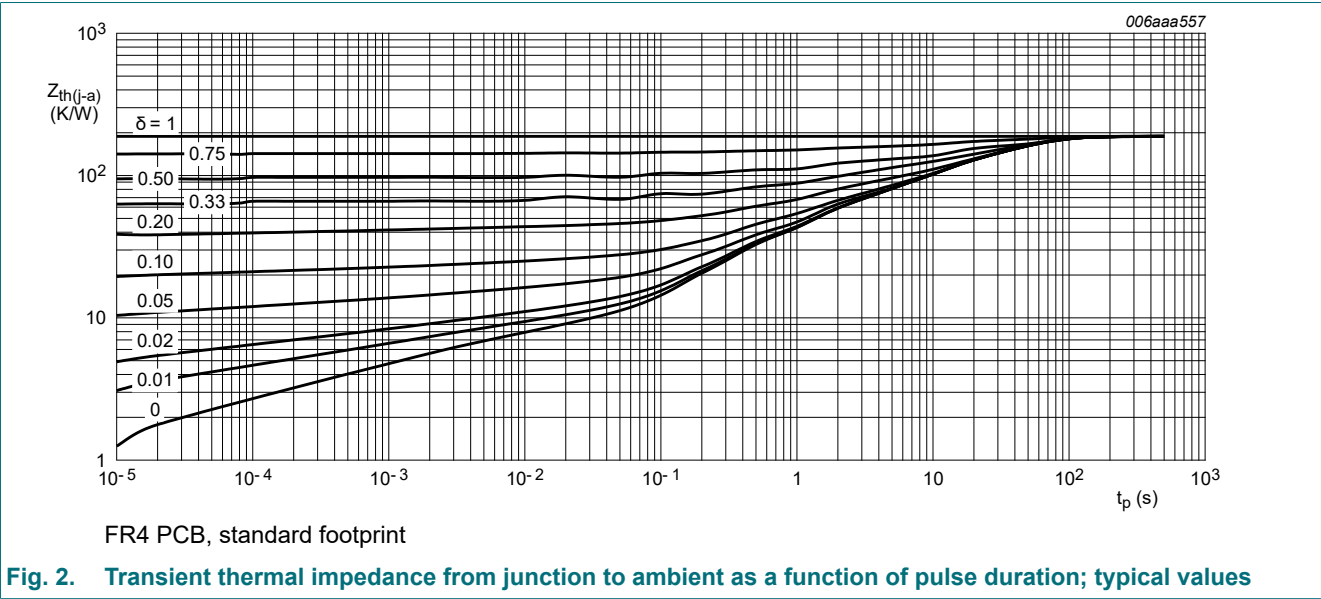


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	208	K/W
			[2]	-	-	76	K/W
			[3]	-	-	60	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	20	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².
[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



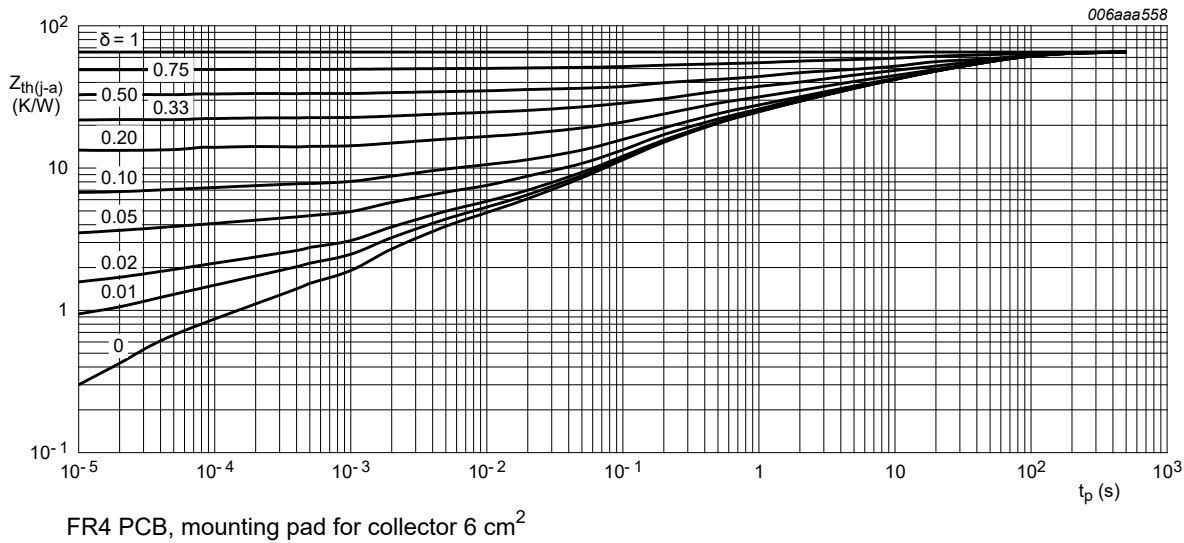


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

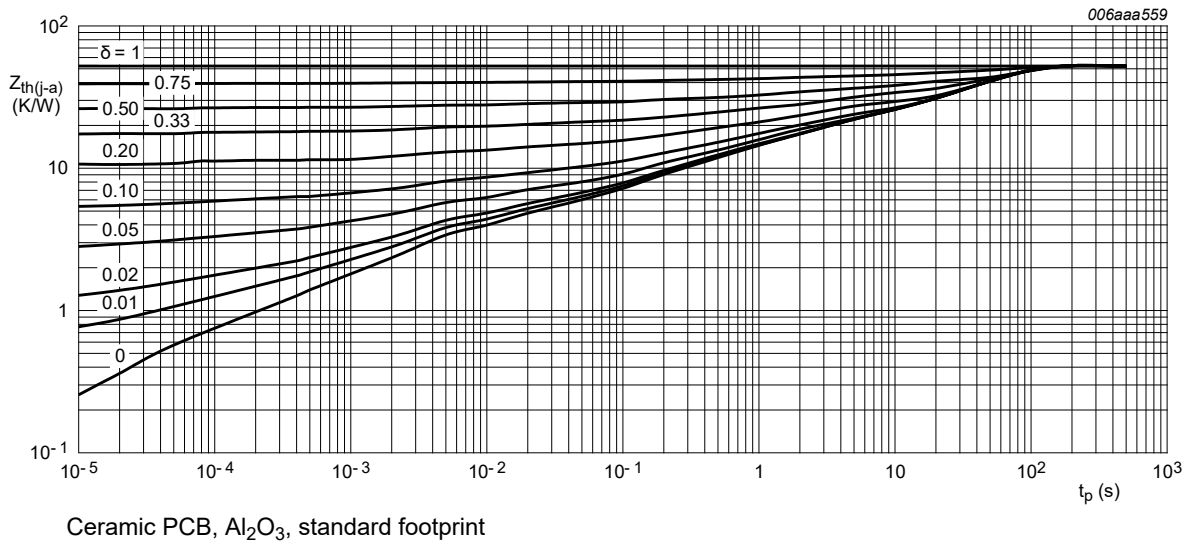


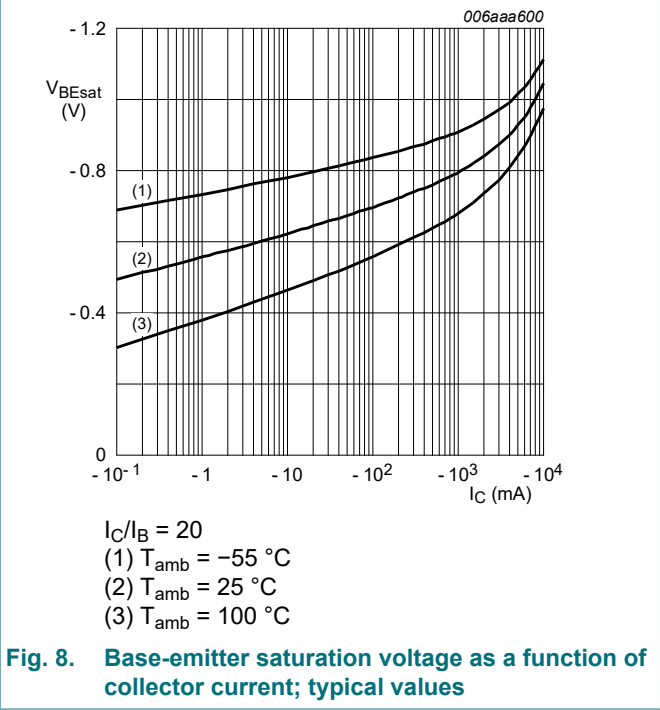
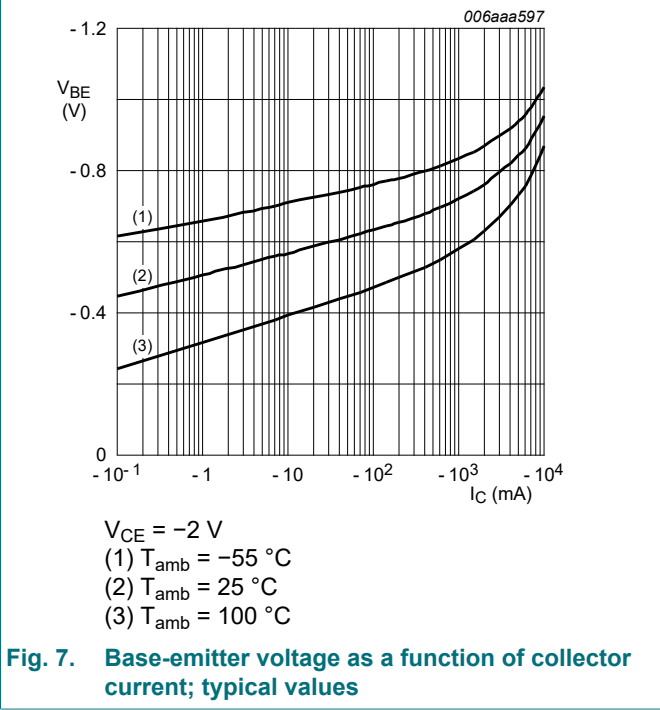
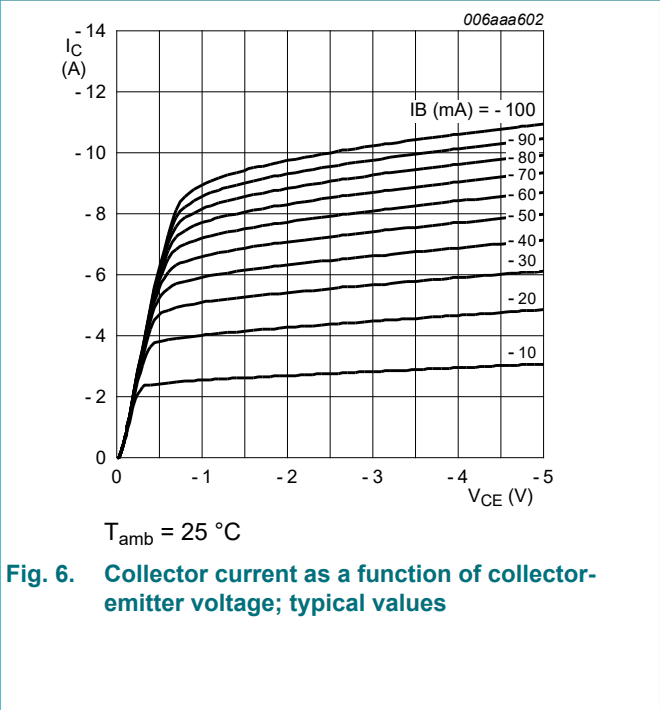
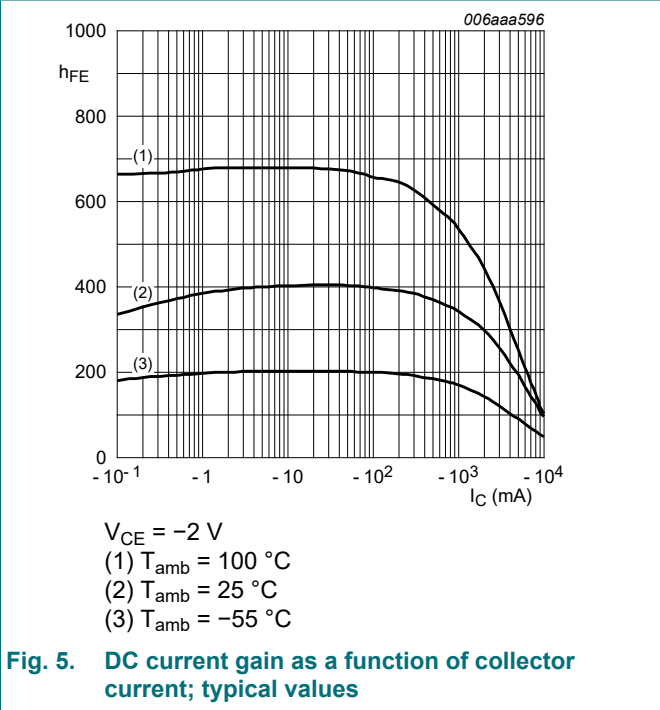
Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{CBO}	collector-base cut-off current	$V_{CB} = -20\text{ V}$; $I_E = 0\text{ A}$; $T_{amb} = 25\text{ °C}$	-	-	-100	nA
		$V_{CB} = -20\text{ V}$; $I_E = 0\text{ A}$; $T_j = 150\text{ °C}$	-	-	-50	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = -5\text{ V}$; $I_C = 0\text{ A}$; $T_{amb} = 25\text{ °C}$	-	-	-100	nA
h_{FE}	DC current gain	$V_{CE} = -2\text{ V}$; $I_C = -0.5\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	250	370	-	
		$V_{CE} = -2\text{ V}$; $I_C = -1\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	250	340	-	
		$V_{CE} = -2\text{ V}$; $I_C = -2\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	200	290	-	
		$V_{CE} = -2\text{ V}$; $I_C = -4\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	150	220	-	
		$V_{CE} = -2\text{ V}$; $I_C = -6\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	100	160	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -0.5\text{ A}$; $I_B = -50\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-25	-35	mV
		$I_C = -1\text{ A}$; $I_B = -50\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-45	-65	mV
		$I_C = -1\text{ A}$; $I_B = -10\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-70	-100	mV
		$I_C = -2\text{ A}$; $I_B = -40\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-90	-130	mV
		$I_C = -4\text{ A}$; $I_B = -200\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-130	-190	mV
		$I_C = -4\text{ A}$; $I_B = -400\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-120	-175	mV
		$I_C = -4\text{ A}$; $I_B = -40\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-200	-300	mV
		$I_C = -5.1\text{ A}$; $I_B = -255\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-160	-230	mV
R_{CEsat}	collector-emitter saturation resistance	$I_C = -4\text{ A}$; $I_B = -200\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	32	48	mΩ
		$I_C = -4\text{ A}$; $I_B = -40\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	50	75	mΩ
V_{BEsat}	base-emitter saturation voltage	$I_C = -1\text{ A}$; $I_B = -100\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-0.82	-0.9	V
		$I_C = -4\text{ A}$; $I_B = -400\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-0.93	-1.05	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2\text{ V}$; $I_C = -2\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-0.76	-0.85	V
t_d	delay time	$V_{CC} = -12.5\text{ V}$; $I_C = -3\text{ A}$; $I_{B0n} = -0.15\text{ A}$; $I_{B0f} = 0.15\text{ A}$; $T_{amb} = 25\text{ °C}$	-	10	-	ns
t_r	rise time		-	55	-	ns
t_{on}	turn-on time		-	65	-	ns
t_s	storage time		-	205	-	ns
t_f	fall time		-	145	-	ns
t_{off}	turn-off time		-	350	-	ns

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f_T	transition frequency	$V_{CE} = -10\text{ V}$; $I_C = -0.1\text{ A}$; $f = 100\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	-	130	-	MHz
C_c	collector capacitance	$V_{CB} = -10\text{ V}$; $I_E = 0\text{ A}$; $i_e = 0\text{ A}$; $f = 1\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	-	130	160	pF



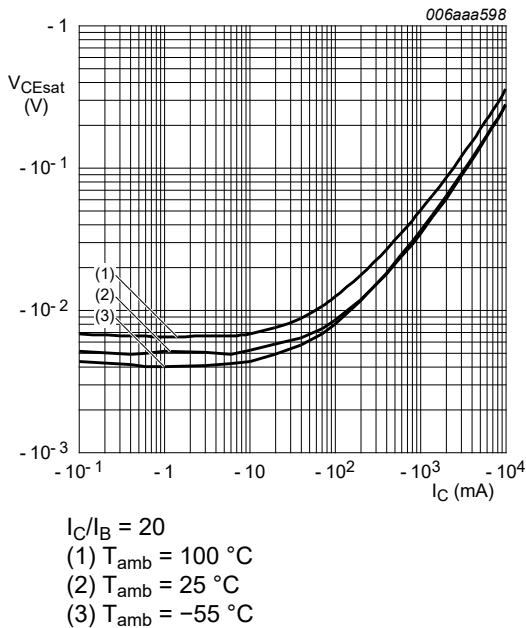


Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values

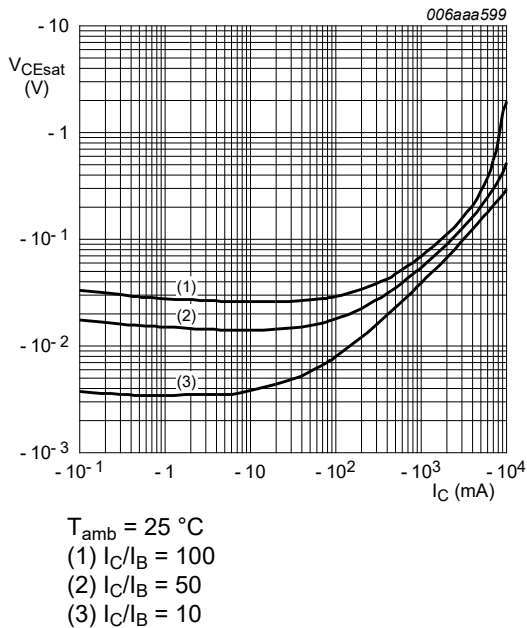


Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values

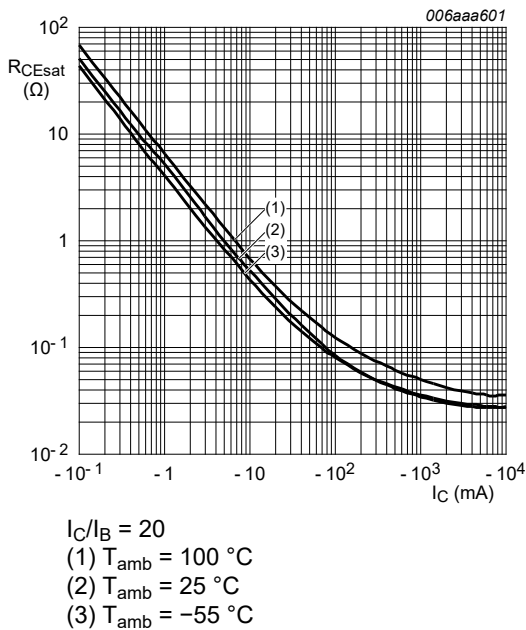


Fig. 11. Collector-emitter saturation resistance as a function of collector current; typical values

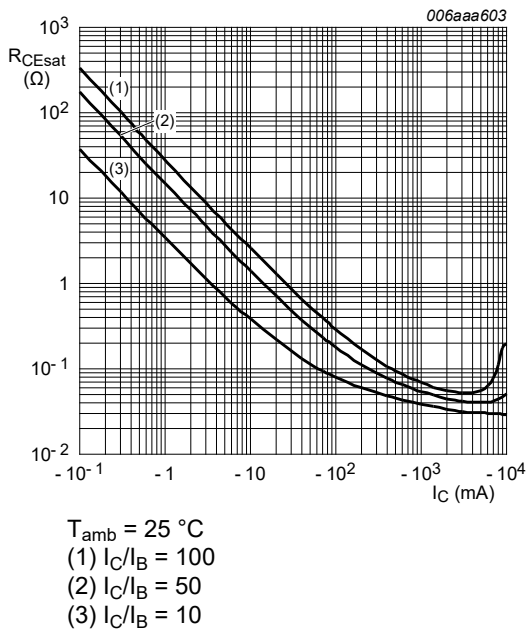


Fig. 12. Collector-emitter saturation resistance as a function of collector current; typical values

11. Test information

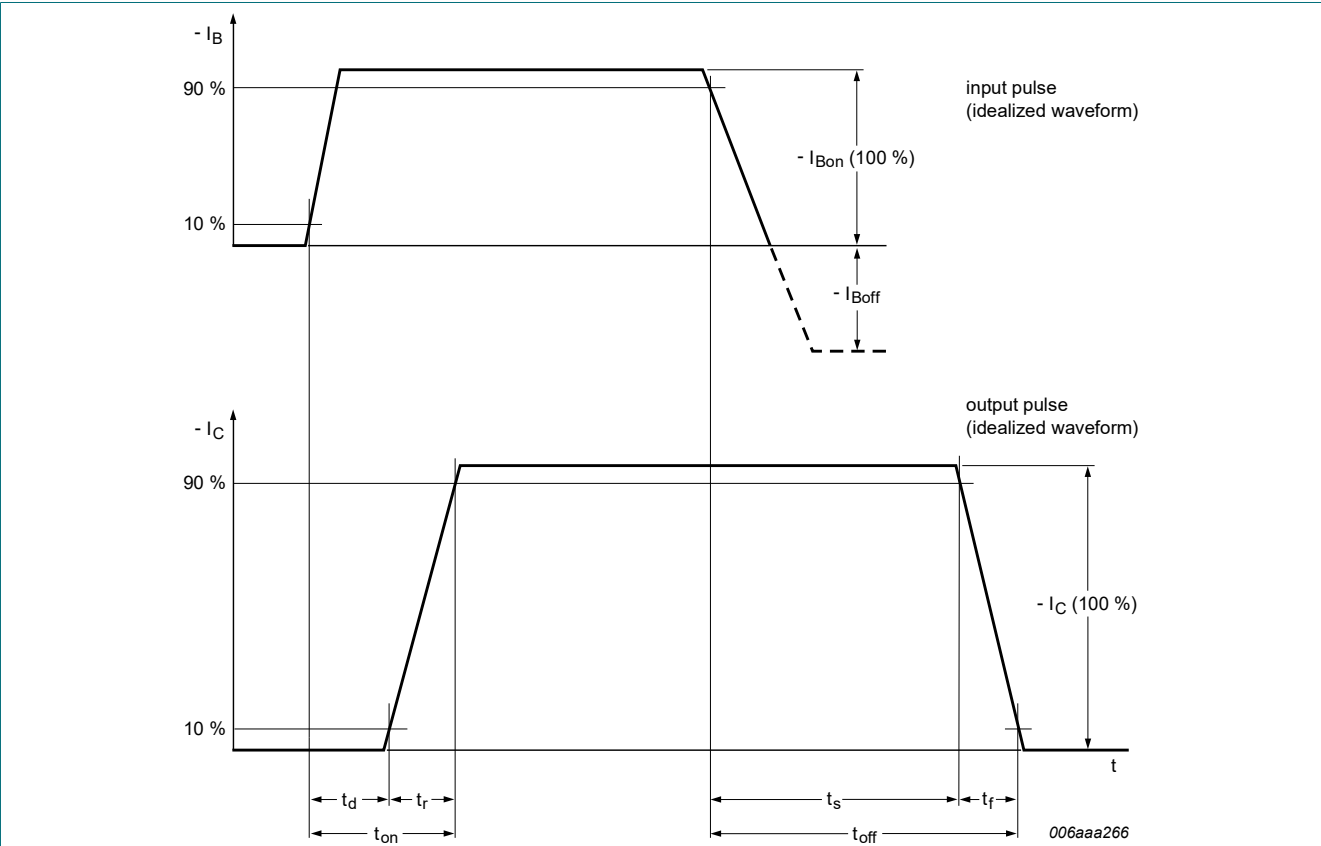


Fig. 13. Transistor switching time definition

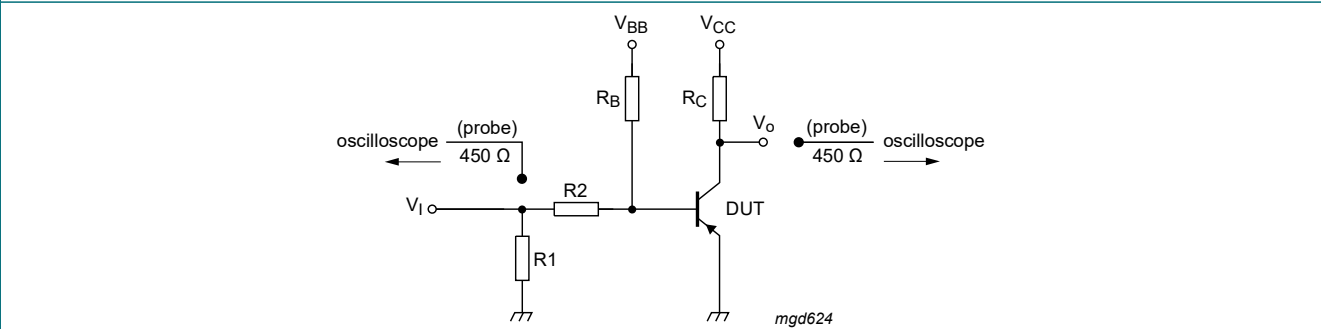
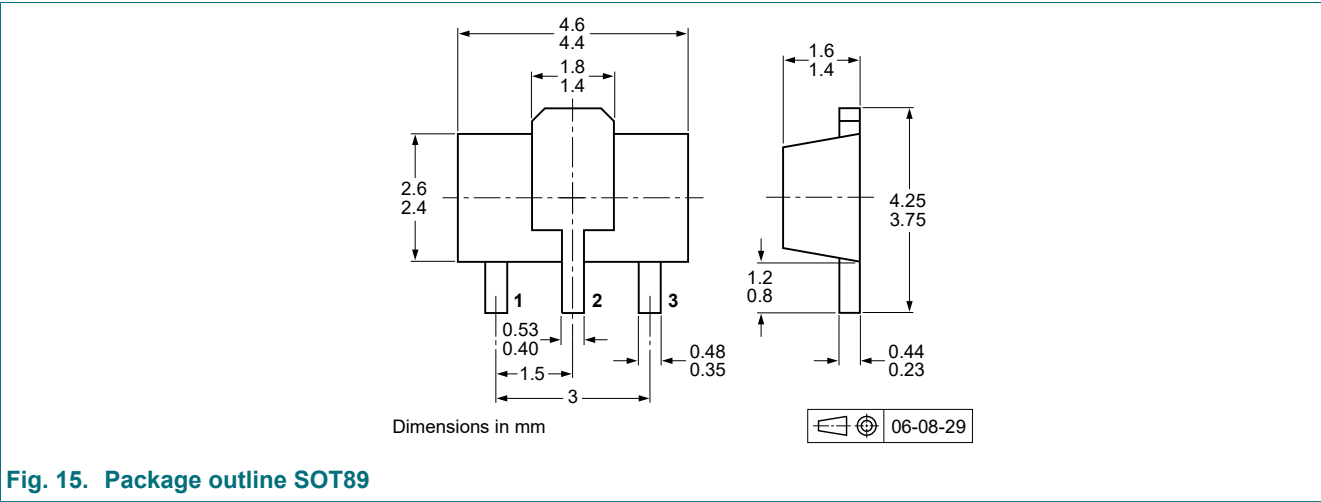


Fig. 14. Test circuit for switching times

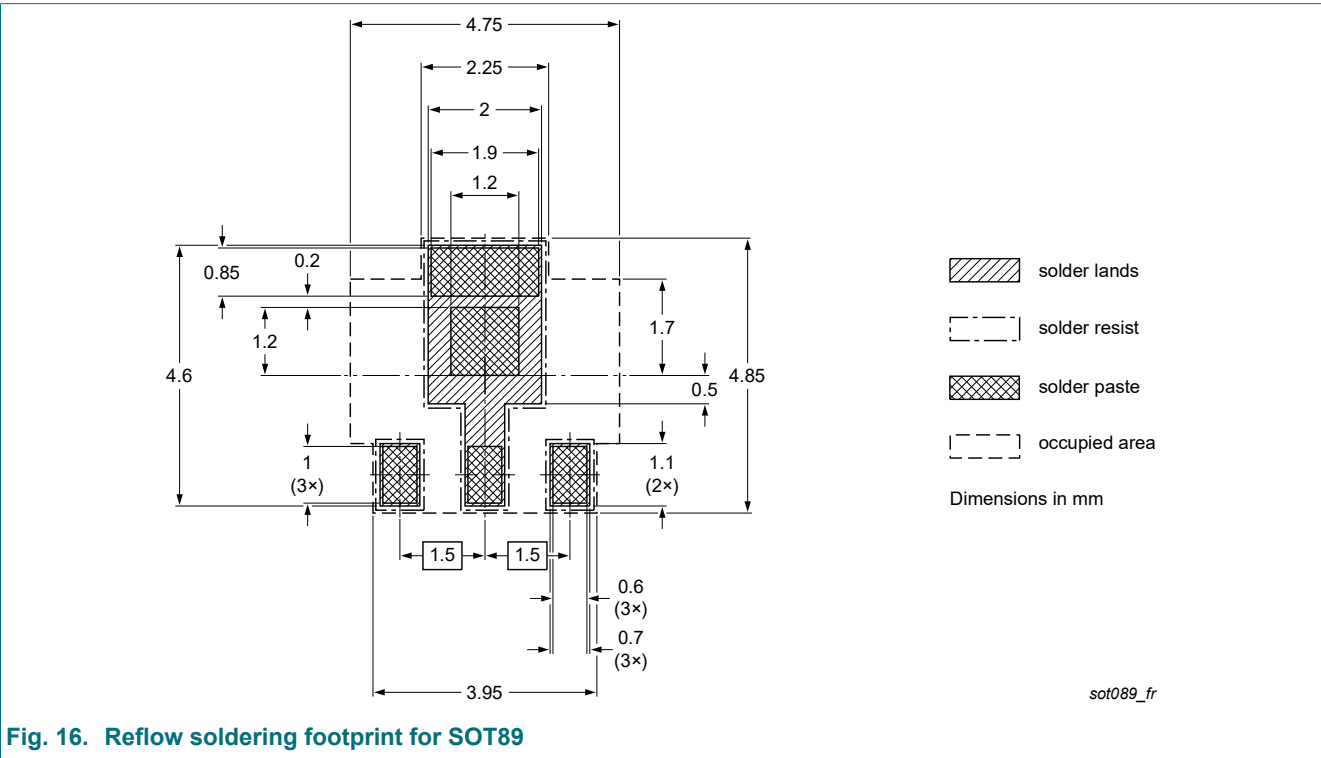
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



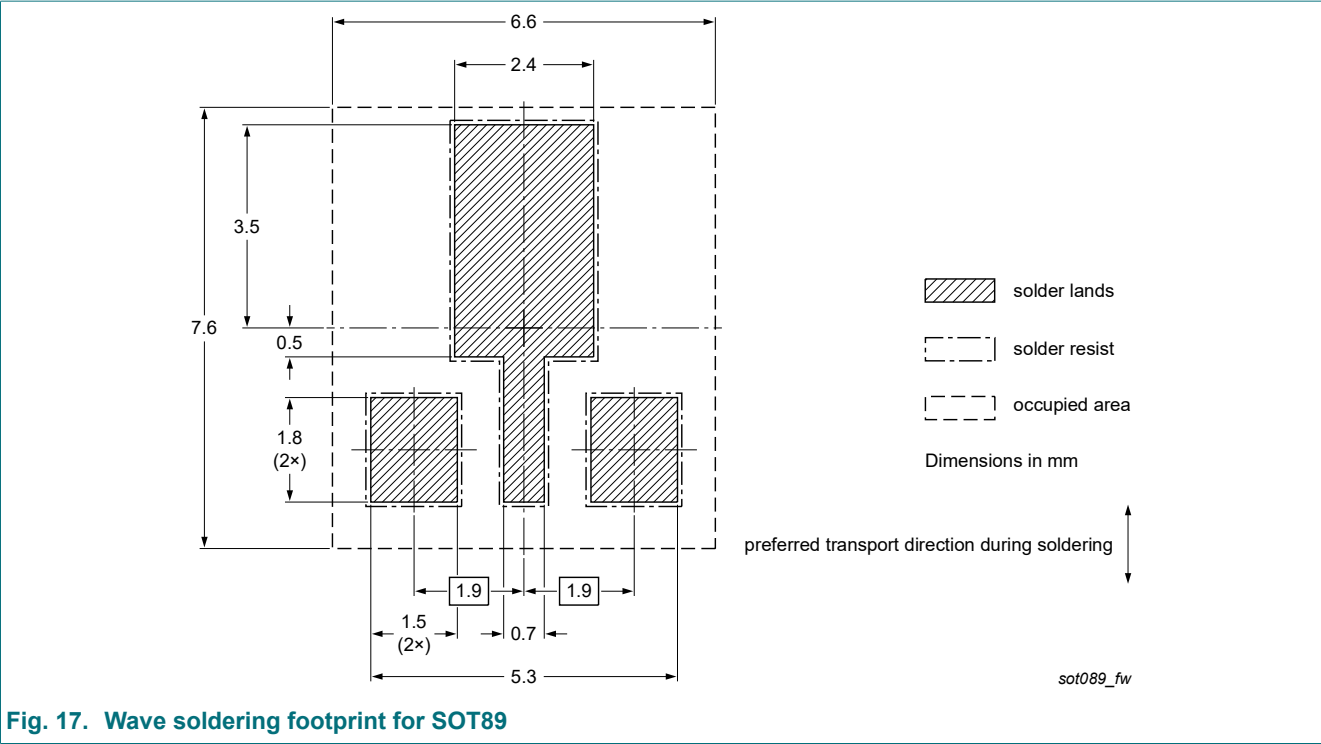


Fig. 17. Wave soldering footprint for SOT89

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS302PX v.3	20240123	Product data sheet	-	PBSS302PX v.2
Modifications:	<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.Legal texts have been adapted to the new company name where appropriate.Section "Packing information" removed.			
PBSS302PX v.2	20091120	Product data sheet	-	PBSS302PX v.1
PBSS302PX v.1	20060823	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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